Fabless semiconductor companies: Is your manufacturing sourcing strategy eroding competitiveness?

By Syed Alam and James Wildenburg
The semiconductor industry today faces a monumental challenge: putting the brakes on a ballooning cost structure that is making many fabless companies uncompetitive. According to Accenture Strategy analysis, as much as 80 percent of a fabless company's revenue is eaten up by the cost of goods sold (COGS)—and the situation is only getting worse. In 2014, top fabless companies spent nearly $33 billion on COGS.1 That's up a startling 65 percent from 2010, and it's caught the attention of investors who increasingly are calling on companies to take action.

Why the sharp increase? Conventional wisdom is a major culprit. Most companies have long believed they perform best when they focus on one manufacturing sourcing strategy and optimize it to become highly efficient. But that thinking is misguided. When companies build rigid processes to support a single strategy, they lose the flexibility to make necessary operational changes to control expenses. Fabless companies' strict adherence to either the Wafer Buy or Known Good Die strategy is constraining their ability to more effectively rein in supply chain costs.

Compounding the problem is that too many fabless companies are defaulting to Known Good Die. They are falling into the convenience trap, paying management fees associated with this strategy when they do not have to or should not—just because it is easy to make foundries responsible for chip production.

At an even more basic level, many fabless companies are not deploying the optimal strategy for their business because they use the wrong criteria to determine which sourcing strategy to adopt. They typically rely on the type of product a chip is destined for or the company's business model to shape their decision. This can lead to a mismatch between the strategy and the needs of business, and compromise a company's ability to control production costs.

In short, fabless companies are squandering millions of dollars and eroding margins because of inefficient manufacturing and testing of chips—and that must change for companies to restore competitiveness and profitable growth.

The solution: embrace a hybrid, flexible approach to manufacturing sourcing.

**Management fees associated with the Known Good Die strategy are adding 2–4 percent to companies’ cost structures.**

The hybrid, flexible manufacturing sourcing approach

With a hybrid, flexible approach, a fabless company can effectively use both the Known Good Die and Wafer Buy strategies, switching from one to the other when business conditions require. Such flexibility enables a company to purchase material at different points in the manufacturing process to balance material costs, risk and yield to meet demand.
For instance, in a Known Good Die strategy, direct material costs are higher, and risk to the fabless company lower, because the foundry actively manages most of the manufacturing process. The converse is true of Wafer Buy. Because the fabless company assumes responsibility for (and the inherent risk associated with) producing sufficient yield to meet demand, it enjoys lower direct material costs and greater control over the manufacturing process.

By selectively using the strategies when it makes sense, a fabless company can maximize each strategy’s strengths while minimizing its weaknesses—and, thus, make the greatest impact on profitability.

That is what Qualcomm, the world’s largest fabless company, has recently done. By actively and flexibly applying both manufacturing sourcing strategies, Qualcomm reduced its overall manufacturing costs—thus enhancing its margins and competitiveness.

The path to competitiveness

Generating the greatest benefit from a hybrid, flexible approach requires implementing the business processes and systems capabilities that can support each manufacturing sourcing strategy. It also requires knowing which strategy to use when, and keeping tabs on performance to ensure the company attains its desired cost and product delivery targets.

Implement the business processes and systems capabilities to support flexibility

In a Known Good Die strategy, fabless companies need business process and systems capabilities to support activities that occur after the receipt of Known Good Die from the foundry, when the company assumes ownership of the material. The main manufacturing steps from this point include three key backend processes: Assembly, Final Test, and Scan-Bake-Tape (SBT).

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Tradeoffs between Known Good Die and Wafer Buy Strategies

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<td><strong>Direct Material Cost</strong></td>
<td><strong>Outsource manufacturing to low cost suppliers</strong></td>
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**Known Good Die Benefits**

- Focused efforts on design and innovation vs. supply chain management
- Guaranteed die order quantity, protected from yield risk

**Wafer Buy Benefits**

- Removal of foundry management fees; ability to select low cost suppliers
- Increased supply chain visibility and control; reduced lead times and product priority decisions

Source: Accenture Strategy analysis, December 2015
In Wafer Buy, fabless companies are responsible for the activities that occur after the receipt of an unprobed wafer from the foundry. Because they assume ownership of the material earlier in the supply chain, they must be able to orchestrate the additional manufacturing steps run by the foundry in the Known Good Die strategy: bump, sort/probe, and wafer-to-die conversion. A company that relies on Known Good Die will need to develop new supporting capabilities unique to probe:

- Procurement of probe hardware
- Probe hardware planning process
- Storage process
- Probe hardware repair and maintenance process
- Pick map process for probed wafers
- Wafer acceptance test criteria/limit process

Determine which strategy to use when

With the necessary business process and system capabilities in place, a company must determine which strategy to use when. That decision is primarily a function of where a product sits in its lifecycle, as illustrated by the semiconductor yield curve.

When a product is developed and introduced, Wafer Buy is the right choice. At this stage, the product design is still being finalized, so a company should have as much insight into the product as possible. Wafer Buy allows for maximum visibility into all stages of manufacturing, enabling the company to collect valuable data during the bump and probe process to optimize manufacturing, more deeply understand design issues, and begin to improve yield prior to high-volume demand. Additionally, because the complexity and risk of managing the supply chain at this stage are low given low initial sales volumes, it is easier for the company to manage the supply chain itself and minimize costs.

As the product moves into the growth stage, demand begins to ramp up and yield becomes more volatile. At this time, minimizing risk to production and mitigating any potential supply issues is critical—which is one of the biggest strengths of Known Good Die. Paying the foundry management fees for Known Good Die may be less costly overall during growth, as it reduces supply risk and enables the company to maximize production.

Source: Accenture Strategy analysis, December 2015
As the product matures, sales level off and decline, and yield becomes more predictable, the optimal strategy once again is Wafer Buy. In the twilight of a product’s lifecycle, managing cost becomes paramount to maintain as much margin as possible in the face of pressure from newer competing products. By regaining full control over the manufacturing process, a fabless company can stop paying management fees to foundries and focus on driving down direct costs by outsourcing manufacturing to low-cost suppliers. It also can quickly shift production priorities to respond to inconsistent demand that is common at this stage.

Technology also plays an important role in determining which strategy to use. When a product using new technology (such as 10nm-14nm) is introduced, yields are not stable for initial wafer lots—thus making Known Good Die more suitable. Yields for older technology (such as 28nm and higher) will stabilize relatively quickly, making Wafer Buy the optimal strategy for most of the product’s lifecycle.

Monitor the performance of each strategy to ensure operations and cost optimization

However, simply plugging in the right strategy does not guarantee results. A company must continually monitor three key factors to understand how well it is executing each strategy and whether opportunities for improvement exist.

One is the product yield curve. Because a products’ yield curve changes as it moves through the product lifecycle, companies should monitor yield closely. Steady yield calls for Wafer Buy and volatile yield signals a likely switch to Known Good Die.

A second is test hardware economies of scale. In Wafer Buy, a fabless company must purchase the test hardware needed for probe manufacturing operations—an upfront cost. But it also can create economies of scale by applying Wafer Buy to additional products over time, thus reducing long-run average costs.

A third is operational efficiency metrics, including on-time delivery of material from foundries and cycle time. Such metrics enable fabless companies to not only determine if they are executing the strategies efficiently, but also to identify whether foundries are delivering on their commitments and suppliers are being appropriately managed through bump and probe activities.

Take action to boost the bottom line

The global semiconductor industry is forecast to maintain steady growth in the next few years, expanding by 2.3 percent to 3 percent between 2015 and 2017. Some analysts are even more bullish, calling for as much as 6 percent growth in 2016.

But top-line growth is not the biggest problem fabless companies face. Given the dynamic nature of the semiconductor industry, and the increasing pressure from investors for better returns, fabless companies need to think more creatively about how to address their increasingly unwieldy cost structure to shore up their bottom line. In particular, they should adapt their sourcing processes, yield management capabilities, costing methods and ERP systems to flexibly support both Wafer Buy and Known Good Die strategies, which can help them rein in COGS.

Qualcomm has already embraced such creative thinking and, consequently, is enjoying improved margins and competitiveness. Similar benefits await other fabless companies that follow Qualcomm’s lead.
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References

1 Accenture research and analysis
2 “WSTS has published the Q2 2015 semiconductor market figures,” World Semiconductor Trade Statistics news release, August 31, 2015.